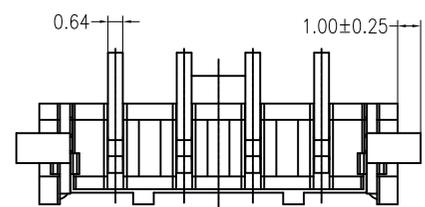
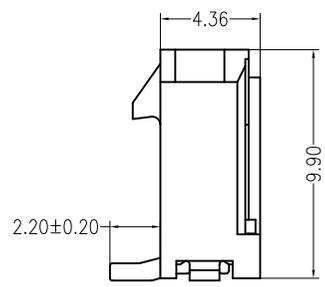
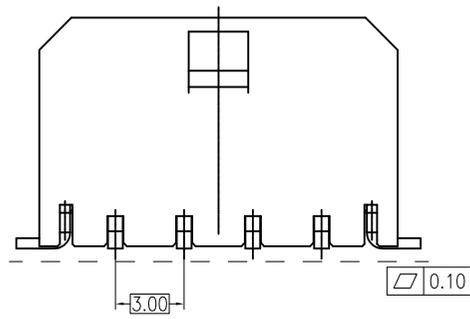
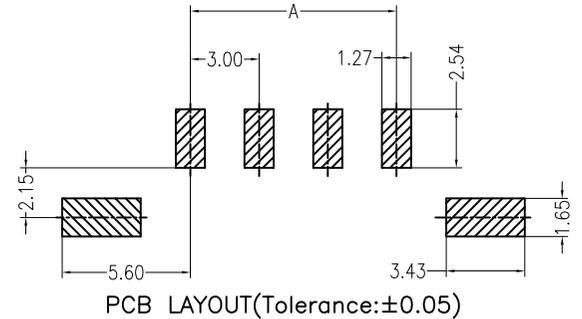
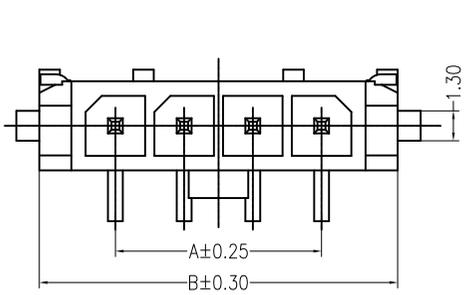


REV	DESCRIPTION	DESIGN	DATE
A0			



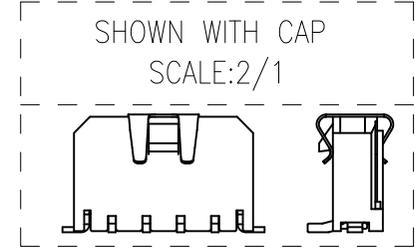
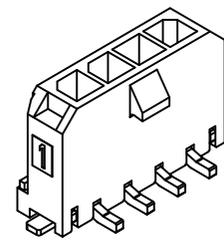
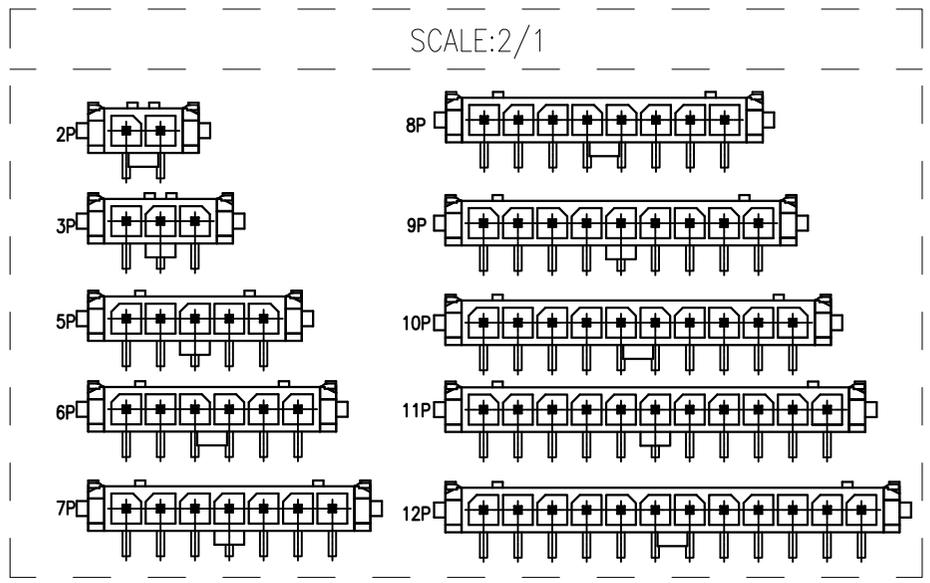
Specifications:
 Contact resistance: ≤10mΩ
 Insulation resistance: ≥1000MΩ
 Rated voltage: 250V AC DC
 Rated current: 5.0A AC DC
 Withstand Voltage: 1000V AC/minute
 Temperature Range: -25℃ ~ +85℃
 Housing: LCP UL94V-0, BLACK
 Contacts: Brass/MATTE Sn-plated
 Solder Tabs: Brass/MATTE Sn-plated
 CAP: Stainless steel

ORDER INFORMATION:

A3001AWV-**-F9KB3-R-X

PART No. _____
 No.OF CIRCUITS: _____
 02-12
 PLASTIC MATERIAL: _____
 F9K=LCP

L X:CAP
 PACKAGING:
 R=REEL
 Metal code:
 J=Brass
 PLATING:
 B=MATTE Sn



PIN	DIM A	DIM B
2	3.00	9.65
3	6.00	12.65
4	9.00	15.65
5	12.00	18.65
6	15.00	21.65
7	18.00	24.65
8	21.00	27.65
*9	24.00	30.65
*10	27.00	33.65
*11	30.00	36.65
*12	33.00	39.65

浙江创都电子科技有限公司				TITLE: 3.0 Pitch Wafer 180° SMT	
				PART NO.: MX3.0-1 × *A-LT	
GENERAL TOLERANCE		USE: CUSTOMER		DWG NO.:	
X. ±0.50	X. ±5°	APPD:		SCALE	
X.X ±0.30	X.X ±2°	CHKD:		1 : 1	
X.XX ±0.20	X.XX ±1°	DR:		SHEET	
UNITS: mm		1 / 1			